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## SPC58EHx/SPC58NHx OctalSPI HyperBus

### Introduction

Nowadays the HyperBus interface technology offers many advantages supporting both legacy and many new features available inside the memory devices. These are for enhancing the overall performance e.g. Single/Double Data Rate (SDR/DDR), simplifying the design (due to low-pin usage) and reducing the global system cost.

To meet the growing requests in the automotive context about the integration of high-speed memories, STMicroelectronics offers the SPC58EHx/SPC58NHx micro-controller family that embeds two OctalSPI interfaces.

These interfaces enable the connection of the OctalSPI and HyperBus high-speed volatile and non-volatile memories available in the market and automotive graduated.

The OctoSPI's memory-mapped mode also allows to access to the external memories as if they were internal ones.

This application note documents how to setup the OctalSPI controllers inside the SPC58EHx/SPC58NHx micro-controller. It provides generic information about the protocols and literature to enter in the topic.

This document aims at explaining how to configure both OctalSPI instances in order to write and read HyperBus memories (HyperRAM and HyperFLASH).

It also describes some typical use cases to use the OctoSPI interface and providing some practical examples on how to use the interface depending on the type of the targeted memory.

This application is written by using SPC5Studio (tool is available at the following URL: <https://www.st.com/en/development-tools/spc5-studio.html>).

## 1 OctalSPI introduction

The OctoSPI is a serial interface which allows the communication on 8 data lines between the micro-controller and an external memory.

The OctoSPI provides a flexible hardware interface, which enables the support of multiple hardware configurations. It supports the Single-SPI (traditional SPI), Dual-SPI, Quad-SPI, Dual Quad-SPI and Octal-SPI.

The SPC58EHx/SPC58NHx OctalSPI has several features:

- Three functional modes: indirect, status-polling, and memory-mapped.
- Read and write support in the memory-mapped mode.
- Supports for single, dual, quad and octal communications.
- SDR and DTR support. Latter is supported and validated on this product.
- Data strobe support.
- Fully programmable opcode.
- Fully programmable frame format.
- HyperBus support.
- Integrated FIFO for reception and transmission.
- 8, 16, and 32-bit data accesses are allowed.
- DMA channel for indirect mode operations.
- Interrupt generation on FIFO threshold, timeout, operation complete, and access error.

This application note is focused on HyperBUS in DDR mode according to the Microcontroller requirements and on Cypress memories.

*Note: for additional information refer to the “Octo-SPI” chapter inside the Microcontroller reference manual (see [Section Appendix C Reference documents](#)).*

### 1.1 OctalSPI protocol and operating modes

The OctoSPI interface can operate in two different low-level protocols:

- Regular command mode.
- HyperBus frame format.

Each protocol supports three operating modes:

- Indirect mode.
- Memory-mapped mode.
- Status-polling mode.

#### 1.1.1 Regular command mode

The regular-command mode is the classical frame format where the OctoSPI communicates with the external memory device by using commands; each command can include up to five phases and, at least, one of the five phases must be present. The interface provides a fully programmable frame support.

#### 1.1.2 HyperBUS mode

The OctoSPI supports the HyperBus protocol which enables the communication with HyperRAM and HyperFlash memories.

The HyperBus has a Double Data Rate (DDR) interface where two data-bytes per clock cycle are transferred over the DQ input/output (I/O) signals, leading to high read and write throughputs.

*Note: for additional information on HyperBus interface operation, refer to the HyperBus specification (see [Section Appendix C Reference documents](#)).*

The HyperBus frame is composed of two phases:

- Command/address phase (CA).
- Data phase.

On the command/address phase, the HyperRAM memory will use the read-recovery time (RWDS) to understand if an additional initial access latency has to be inserted.

The OctoSPI peripheral can be configured in the following HyperBus modes:

- HyperBus memory mode: to allow the read/write access from/to the HyperBus memory.
- HyperBus register mode: to access to the memory device register space.

See [Section Appendix A HyperBus timing](#) for timing considerations.

## 1.2 OctalSPI operating modes

### 1.2.1 Indirect mode

The indirect mode is used either for both HyperBus and regular-command protocols.

The commands are started by writing to the OCTOSPI registers and the data is transferred by writing or reading the data registers.

Typically, this mode is adopted to configure the external memory or resetting/erasing a HyperFLASH device.

In the next chapters, this mode is implemented, and related examples are provided on both HyperRAM and HyperFLASH cases but only on the supported HyperBus mode.

### 1.2.2 Memory-mapped mode

The external memory device is seen as an internal one, but no more than 256 MB can be addressed in this architecture. The MCU can also execute code from the external memory. The application shows how to configure and debug this mode.

The memory mapped regions for both OctalSPI instances are reported in [Table 1. OctalSPI memory map](#).

### 1.2.3 Status polling mode

This feature is used to avoid the polling made by the software when, for example, the memory has been configured or when the ongoing operation (like FLASH programming/erasing) is completed. In automatic-polling mode, in fact, the OctoSPI hardware can periodically read the status and data generating an interrupt on a matching flag.

## 2 SPC58EHx/SPC58NHx OctalSPI mapping

Each instance has its own chip select. The below table indicates the memory map layout:

**Table 1. OctalSPI memory map**

Instance	Description	Address space
OctalSPI 1	Memory mapped	0x70000000 - 0x7FFF_FFFF
	Controller Registers	0x80000000 - 0x8000_03FF
	Delay Block	0x80000400 - 0x8000_0407
OctalSPI 2	Memory mapped	0x60000000 - 0x6FFF_FFFF
	Controller Registers	0x80001000 - 0x800013FF
	Delay Block	0x80001400 - 0x80001407

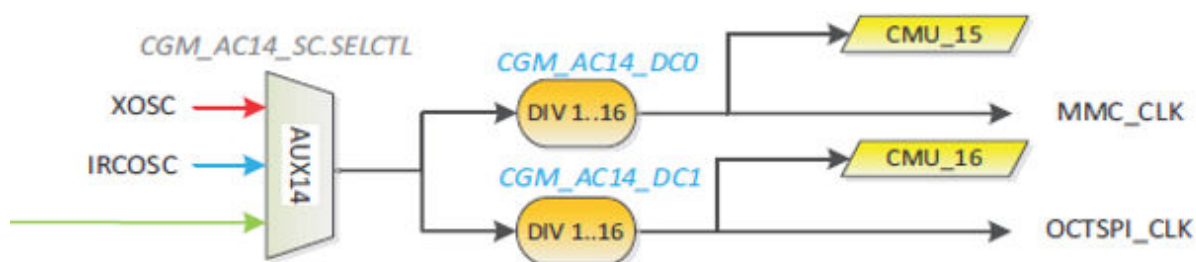
The two OctalSPI share the same data lines to reduce the number of signals and a dedicated IO manager is used to mux them.

The IO manager is mapped at 0x80002000 - 0x8000200B. For full description point to the micro-controller reference manual.

### 3 OctalSPI clock selection

The CGM registers `CGM_AC14_DC1` (Aux Clock 14 Divider Configuration 1) and `CGM_AC14_SC` (Aux Clock 14 Select Control) have to be configured to provide the right clock to the controllers.

**Figure 1. OCTSPI\_CLK GCM selection**



The `OCTSPI_CLK` is configured to 200 MHz (from PLL); a pre-scaler is adopted later by programming the controller registers (see [Figure 3. OctalSPI prescaler selection \(200 / 2 = 100 MHz\)](#)) to obtain 100 MHz, this is the default clock in this application for both instances.

**Figure 2. Application clock details (SPC5Studio wizard)**

Calculated Clock Points			
XOSC	40000000	IRC	16000000
PLL0-IN	40000000	PLL0-VCO	800000000
PLL0-PHI	200000000	PLL0-PHI1	400000000
PLL1-IN	40000000	PLL1-VCO	800000000
PLL1-PHI0	200000000		
SYSCLK	200000000		
CORE_CLK	200000000	HPBM_CLK	100000000
PBRIDGE_CLK	50000000	FBRIDGE_CLK	200000000
PFBRIDGE_CLK	100000000		
SARADC_CLK	5000000	EMIOS_CLK	50000000
FRAY_CLK	20000000	I2S_CLK	20000000
RTC_CLK	32000	SYSCLK0_CLK	0
CANCLK0_CLK	8000000		
PIT_RT1_CLK	8000000		
CANCLK1_CLK	8000000		
DSPI_CLK0	50000000	DSPI_CLK1	50000000
LIN_CLK0	100000000	LIN_CLK1	100000000
PER_CLK0	50000000		
CANCLK2_CLK	8000000		
MMC_CLK	40000000	OCTSPI_CLK	200000000
PER_CLK1	50000000		

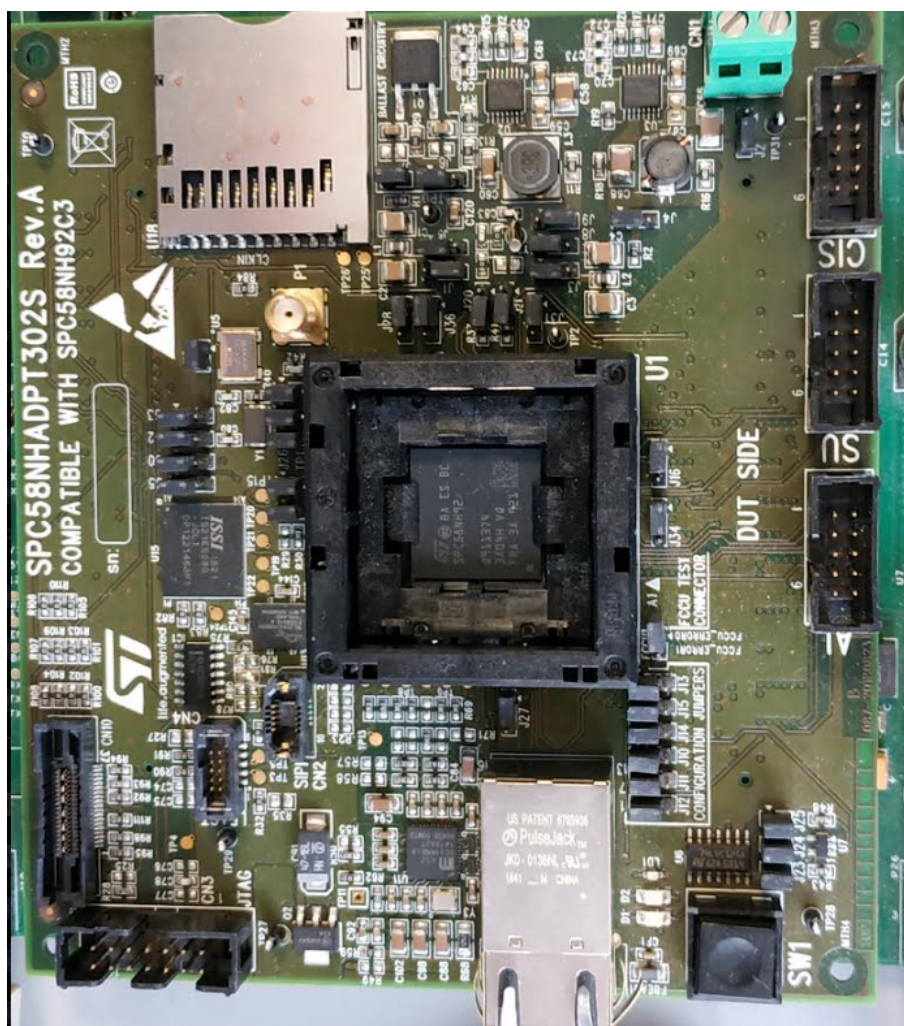
Figure 3. OctalSPI prescaler selection (200 / 2 = 100 MHz)

OctalSPI - Octal Serial Peripheral Interface			
CR	30000009	EN	1: OCTOSPI is enabled
		ABORT	0: No abort requested
		DMAEN	0
		TCEN	1
		DQM	0: Dual-quad mode disabled
		FSEL	0
		FTHRES	0
		TEIE	0: Interrupt disabled
		TCIE	0: Interrupt disabled
		FTIE	0: Interrupt disabled
		SMIE	0: Interrupt disabled
		TOIE	0: Interrupt disable
		APMS	0
		PMM	0
		FMODE	3: Memory-mapped mode
DCR1	04180000	CKMODE	0
		FRCK	0: CLK is not free running
		RESERVED	00
		CSHT	0
		DEVSZ	24
		MTYP	4
DCR2	00000001	PRESCALER	01
		WRAPSIZE	0

## 4 Hardware setup

The OctalSPI instances can be tested on different platforms designed for this MCU family. In this application, the SPC58NHADPT302S board is the reference PCB.

**Figure 4. SPC58NHADPT302S board**





## 5 HyperRAM multi-chip package

The SPC58NHADPT302S embeds the S71KL256SC0BHB000 by Cypress that's an HyperFlash and HyperRAM multi-chip package composed by:

- S26K HyperFlash device.
- S27K HyperRAM device.

Software can dialog with the two devices by using the OctalSPI instances **but not simultaneously**.

For HyperFlash and HyperRAM operating conditions refer to cypress related datasheets.

*Note: the OCTOSPI\_1 chip select (CSN0) addresses the HyperRAM (on CS2#) while the OCTOSPI2 (CSN1) addresses the HyperFLASH (on CS1#).*

Figure 5. S71KL256SC0BHB000 package

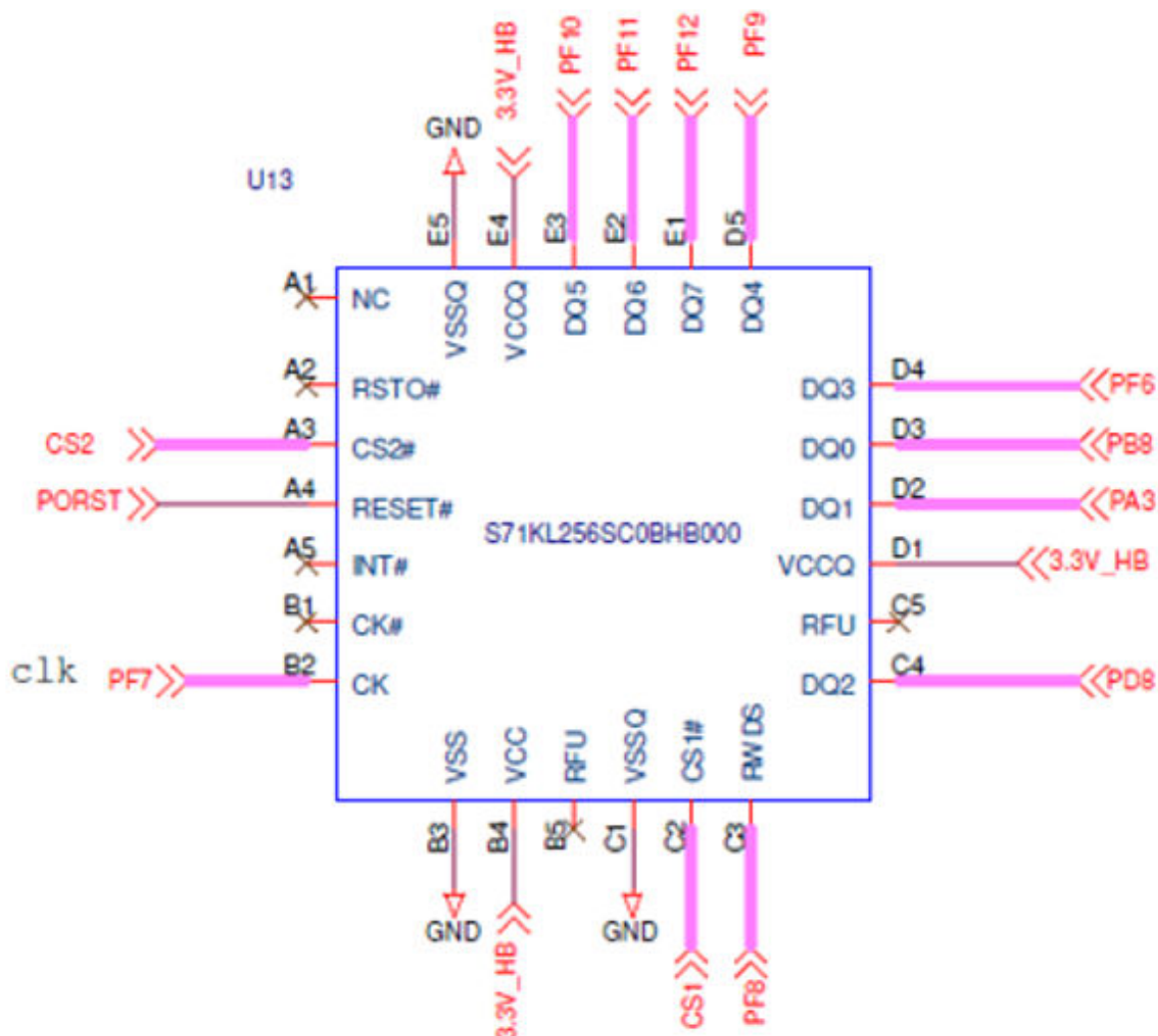
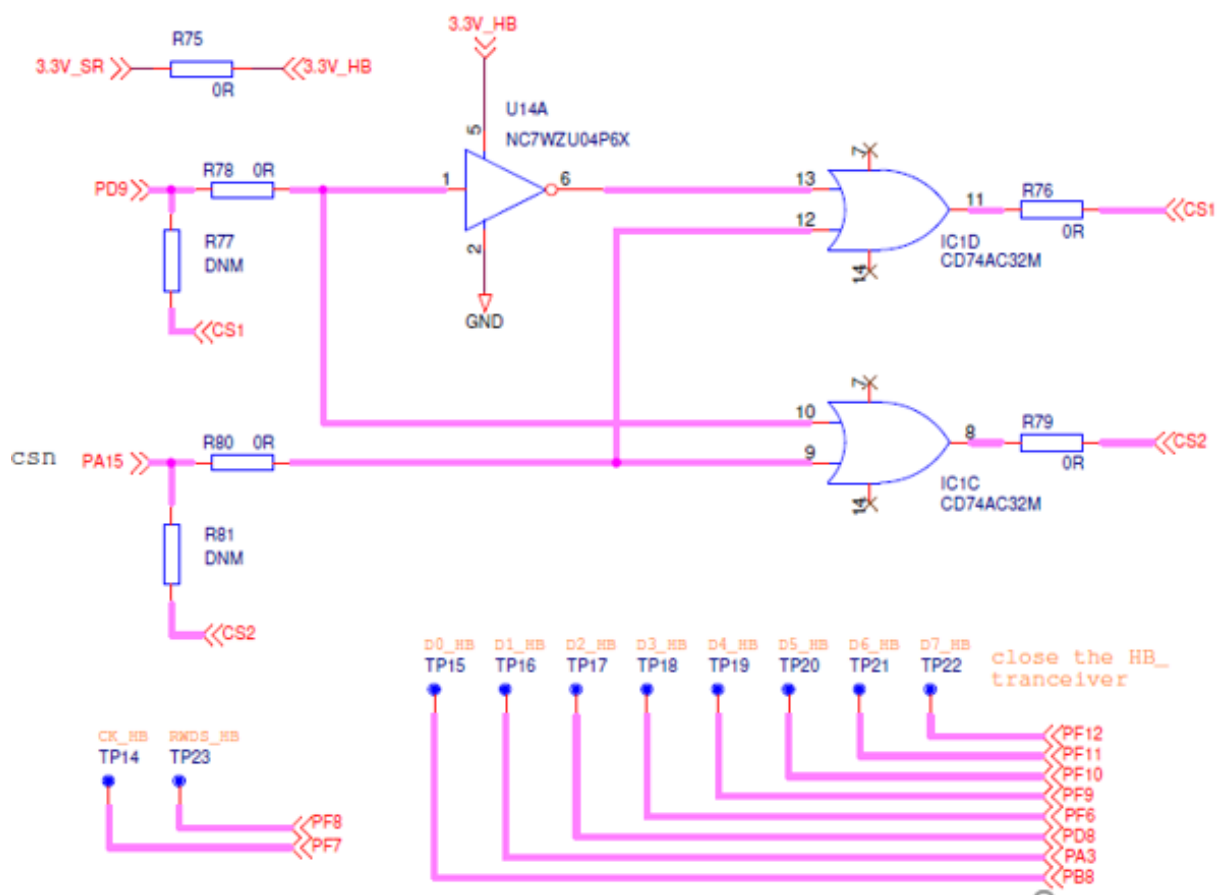




Figure 6. S71KL256SC0BHB000 wiring



Note: Ensure that on this PCB the following resistors R78, R80, R76 and R79 are removed and 0 Ohm fits to R81 and R77 instead of 0 Ohm fits to both R81 and R77.

## 6 OctalSPI signals

The OctoSPI interface uses up to eleven lines:

- CNS line for chip select.
- CLK line for clock.
- DQS line for data strobe.
- DQ[0...7] eight lines for data.

Below the configuration of the pins used in this application for this micro-controller:

**Table 2. OctalSPI IO mapping**

Port	SIUL MSCR#	MSCR SSS	Function	Description	Dir
<b>OctalSPI 1 and OctalSPI 2 - Data signals</b>					
PN[8]	216	00000010	DATA0	OctalSPI Data 0	i/o
PN[8]	912	00000001	DATA0	OctalSPI Data 0	i
PN[9]	217	00000010	DATA1	OctalSPI Data 1	i/o
PN[9]	913	00000001	DATA1	OctalSPI Data 1	i
PN[10]	218	00000010	DATA2	OctalSPI Data 2	i/o
PN[10]	914	00000001	DATA2	OctalSPI Data 2	i
PN[11]	219	00000010	DATA3	OctalSPI Data 3	i/o
PN[11]	915	00000001	DATA3	OctalSPI Data 3	i
PN[13]	221	00000010	DATA4	OctalSPI Data 4	i/o
PN[13]	916	00000001	DATA4	OctalSPI Data 4	i
PN[14]	222	00000010	DATA5	OctalSPI Data 5	i/o
PN[14]	917	00000001	DATA5	OctalSPI Data 5	i
PN[15]	223	00000010	DATA6	OctalSPI Data 6	i/o
PN[15]	918	00000001	DATA6	OctalSPI Data 6	i
PO[0]	224	00000010	DATA7	OctalSPI Data 7	i/o
PO[0]	919	00000001	DATA7	OctalSPI Data 7	i
<b>OctalSPI 1 and OctalSPI 2 – Clock and DQS</b>					
PP[14]	254	00000010	CLK	OctalSPI Clock	i/o
PP[14]	920	00000001	CLK	OctalSPI Clock	i
PQ[1]	257	00000010	DQS	OctalSPI Data strobe	i/o
PQ[1]	911	00000010	DQS	OctalSPI Data strobe	i
<b>OctalSPI 1 and OctalSPI 2 – Chip select</b>					
PD[9]	57	00000111	CSN1	OctalSPI 2 Chip select	o
PN[12]	220	00000010	CSN0	OctalSPI 1 Chip select	o

In the SIUL2 configuration the Output Edge Rate Control (OERC) bit for output pins should be set as very strong / ultra strong drive.

## 7 Delay block overview

The delay block module is integrated with the OctalSPI to generate a delay on DQS signal. This block is designed to be used for both SDR and DDR modes. Only the DDR mode and 100 MHz as frequency are supported.

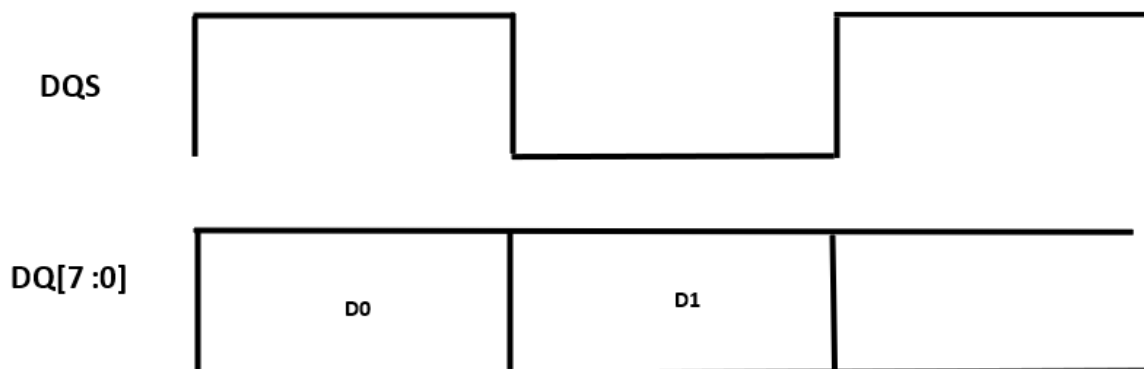
The usage of delay block allows to align the DQS edge to start the valid data window eye and try to give the maximum hold margin.

Generally, data and DQS are edge aligned so there is no extra delay necessary, in any case, the application can tune at runtime the block according to the concurrency of some events (e.g. temperature variation).

### 7.1 Delay block timing example

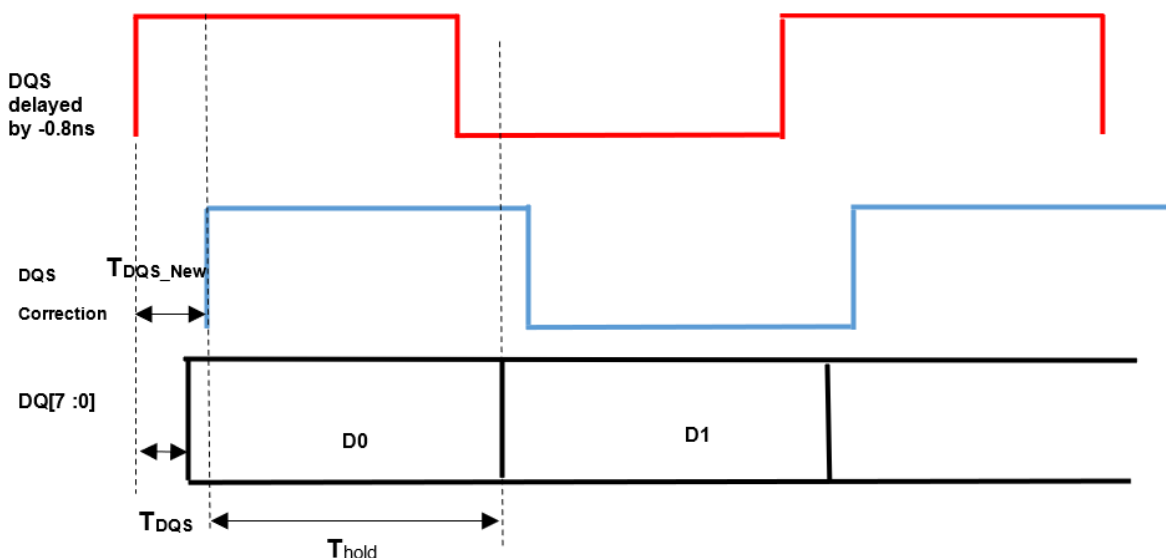
The DQS delay range can vary according to the memory type and constructor. This paragraph shows an example of the delay block timing adopted on this reference platform. According to Cypress HyperRAM timing parameter specification, for 3.0 Volt, in case of 100 MHz the RDWS, that is mapped on DQS, can be -0.8 or +0.8 ns.

**Figure 7. DQS and data signals aligned**



So considering the case where the DQS introduces a delay of -0.8 ns, it is before the DQ [7:0] (issue on properly toggling the data).

Note that the delay introduced by the internal logic ( $T_{PAD}$ ) on DQS w.r.t. DQ [7:0] lines must be also considered. This delay is ranging from 50 ps to 2.1 ns. The following figure shows the correction and hold margin when the delay block applies to a positive shift of 1/12.

**Figure 8. DQS is delayed by -0.8 ns and DLYBLK adds 1/12 as correction**


The following formulas can be considered to calculate the correction:

$$T_{correct} = T_{DLY} + T_{PAD}$$

$$T_{DQS\_New} = T_{correct} + T_{DQS}$$

$T_{hold}$  is the time to toggle data valid after the RWDS edge.

$$T_{hold} = T_{half\_period} - T_{DQS\_New}$$

Where the  $T_{half\_period}$  is 4.5 ns, the minimum half period according to the Cypress Hyperbus specification at 100 MHz.

**Table 3. Hold margin according to a DQS delayed by - 0.8 ns**

$T_{DLY}$		$T_{DQS}$	$T_{PAD(min)}$	$T_{correct}$	$T_{DQS\_New}$	$T_{hold}$
Sel/Unit	[ns]	[ns]	[ps]	[ps]	[ns]	[ns]
1/10	1	-0.8	50	1050	0.25	4.25
1/12	0.8		50	850	0.05	4.45
2/10	2		50	2050	1.25	3.25
2/12	1.6		50	1650	0.85	3.65

**Table 4. Hold margin according to a DQS delayed by + 0.8 ns**

$T_{DLY}$		$T_{DQS}$	$T_{PAD(max)}$	$T_{correct}$	$T_{DQS\_New}$	$T_{hold}$
Sel/Unit	[ns]	[ns]	[ps]	[ps]	[ns]	[ns]
1/10	1	+0.8	2100	3100	3.9	0.6
1/12	0.8		2100	2900	3.7	0.8
2/10	2		2100	4100	4.9	-0.4
2/12	1.6		2100	3700	4.5	0

When the DQS anticipates the data ( $T_{DQS} = - 0.8$  ns), as mentioned in Table 4. Hold margin according to a DQS delayed by + 0.8 ns, applying a  $T_{DLY}$  of 1/12 or 1/10 there is a margin to toggle the data and  $T_{hold}$  is quite high.

In the second case, when the DQS is after than the data ( $T_{DQS} = +0.8$ ), selecting a  $T_{DLY}$  equals to 2/10 or 2/12 the  $T_{hold}$  is reduced so this  $T_{DLY}$  selection should be avoided and a delay of 1/12 or 1/10 remains a reasonable choice.

Concluding, in this specific case for this platform and test condition, applying a  $T_{DLY}$  from 1/12 to 1/10 can guarantee acceptable margins to toggle the right data in time.

## 7.2 Delay block enable

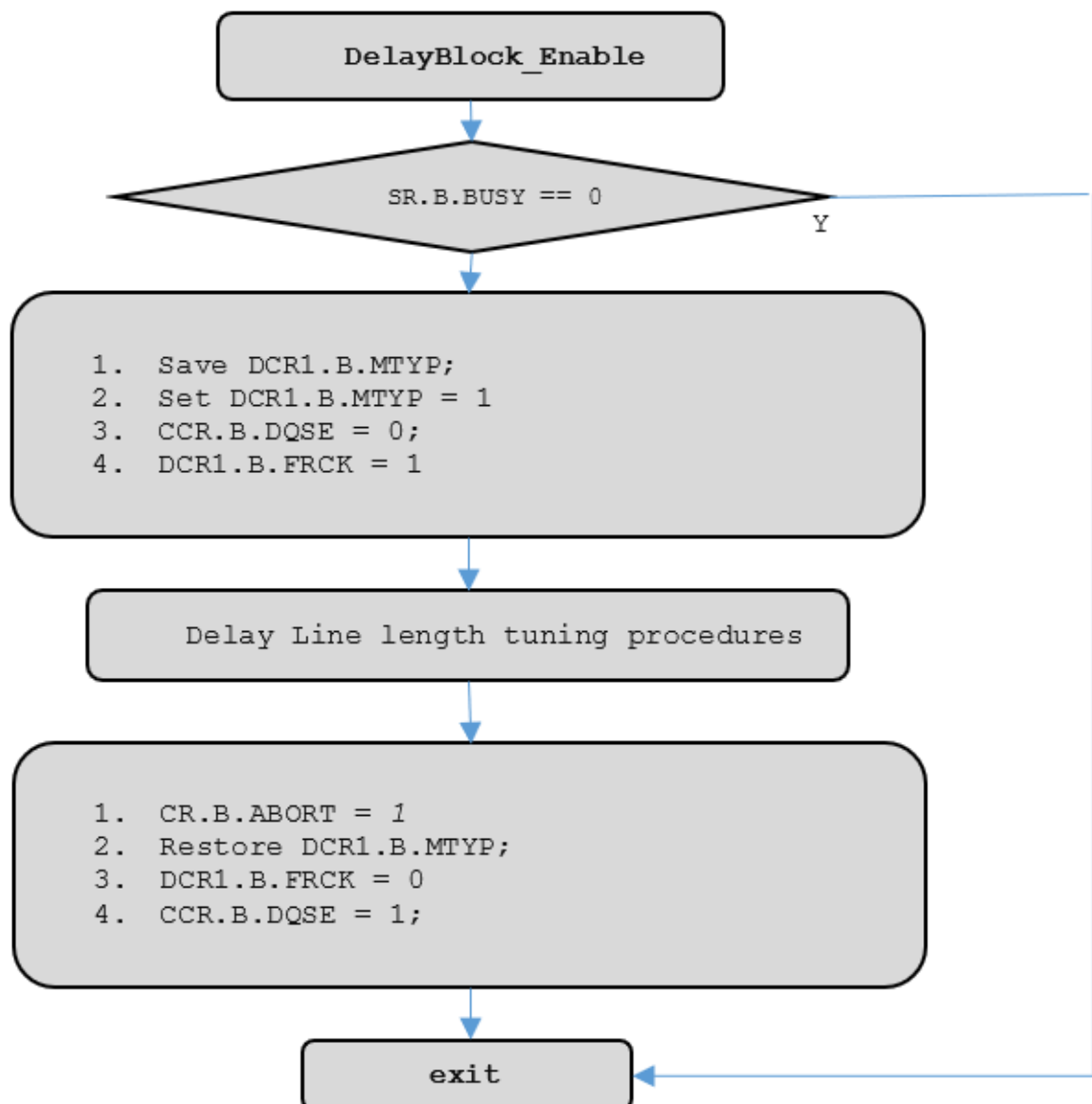
The `DelayBlock_Enable` function is the entry point to enable the module and execute the tuning procedure. This function can be called when the OctalSPI instance is initialized.

Before re-calibrating the delay block, If `SR.B.BUSY` is set to 1, the `DelayBlock_Enable` has to save some parts of the configuration and after raising an `ABORT` it can start tuning the block as described in the next paragraph.

The initial status will be restored after completing the whole procedure.

Any error condition will be reported to the caller function.

**Figure 9. Delay block enable procedure**



## 7.3 Delay block length tuning

When the delay block is enabled the following algorithm must be adopted to tune the lanes and select the delay desired on this platform.

Below an extract of the delay line length tuning procedures implemented inside the `DelayBlock_Enable` function and related to the full period measurement.

```
uint32_t unit = 0;
uint32_t tuning_done = 0;
uint32_t length_value;

//Enable Sampler and Delay blocks
OCTALSPI.DELAY_CTRL.B.SE = 1U;
OCTALSPI.DELAY_CTRL.B.DE = 1U;

//Enable all 12 delay cells
OCTALSPI.DELAY_CFG.B.DELAYSEL = 12U;

for(unit = 0; DLYB_MAX_UNIT >= unit; unit++)
{
    //apply new DELAYUNIT
    OCTALSPI.DELAY_CFG.B.DELAYUNIT = unit;
    //Wait for DELAYF
    while (0U == OCTALSPI.DELAY_CFG.B.DELAYF)
    {
        NOP();
    }

    length_value = OCTALSPI.DELAY_CFG.B.DELAYLENGTH;

    //0111_11x0_0000 >>> FULL_PERIOD we detect 2nd falling edge
    if((0U < length_value) && (0U == (length_value & DLYB_CFGR_LNG_11)))
    {
        //tuning is finished properly
        tuning_done = 1;
        break;
    }
}

if(1U == tuning_done)
{
    //set the delay to 1/12 of CLK period
    OCTALSPI.DELAY_CFG.B.DELAYSEL = 1;
    //Sample length disabled
    OCTALSPI.DELAY_CTRL.B.SE = 0;
    //Delay Block enabled (output clock generated with the selected phase)
    OCTALSPI.DELAY_CTRL.B.DE = 1;
}
else
{
    //The algo did not find the right DELAYUNIT. The CLK period is probably too slow.
    //Issue may be reported to upper SW layer end/or Delay block may be disabled

    //only for debugging !
    OCTALSPI.DELAY_CFG.B.DELAYSEL = 1;
    OCTALSPI.DELAY_CTRL.B.DE = 0U;
    OCTALSPI.DELAY_CTRL.B.SE = 0U;
    OCTALSPI.CR.B.EN = 0U;
    OCTALSPI.DCR1.B.FRCK = 0U;
    while(1);
}
```

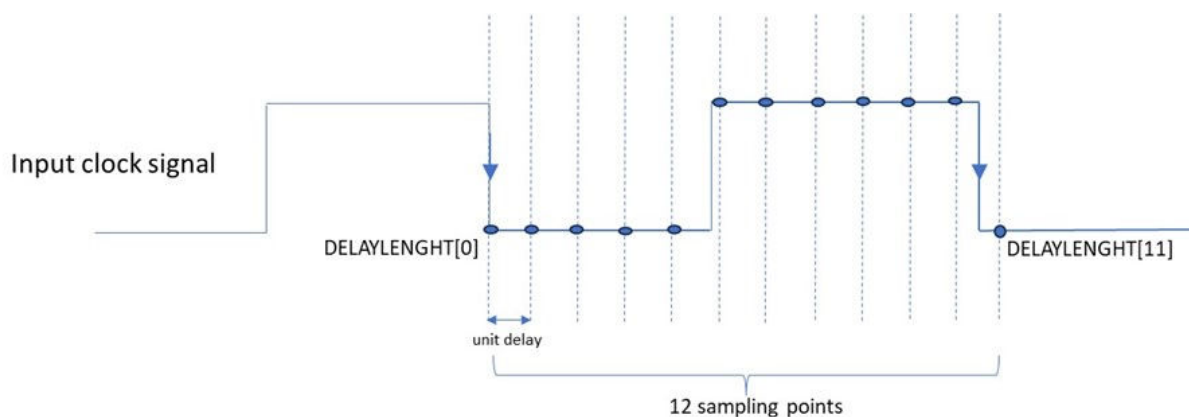
**Note:** *Used values* `#define DLYB_MAX_UNIT 127U` `#define DLYB_CFGR_LNG_11 0x800U`.

### 7.3.1 Code/algorithm description

The algorithm proposed consists of tuning the delay block on a full period.

DELAYLENGHT field can be considered as a shift register containing the sampling of the input clock signal done every delay unit (defined by the correspondent DELAYUNIT field) once the falling edge of the input clock is triggered, as described in the picture below.

Figure 10. Delay block tuning



The algo increases the duration of delay units (from 0 to 127) until the entire period is covered, passing through following phases:

1. As long as  $12 \times \text{delay units}$  is lower than half a period, DELAYLENGHT field will remain at 0x0.
2. When " $12 \times \text{delay units}$ " is between half a period and a period, the first bits of DELAYLENGHT will be at 0, and the last bits will be at 1.
3. When " $12 \times \text{delay units}$ " is just greater than a full period, then the first bits of DELAYLENGHT will be at 0, then we will see some bits at 1, then the last bit (DELAYLENGHT[11]) will be at 0.

The condition 3) determines the completion of the tuning.

There is also the possibility to tune the delay block on a half period: in this case, it can be considered completed when the " $12 \times \text{delay units}$ " is just greater than a half period with the last bit of DELAYLENGHT at 1 and all the others at 0.

Such kind of algorithm can be optimized and modified according to the hardware constraints and not to typical temperature conditions. In some cases, further corrections need to be adopted for TDLY to guarantee a better alignment of the RWDS with the data signals. In fact, the delay selection in this example, is in-line with the timing calculated on this specific platform on normal temperature conditions. The application could retune the delay block when the voltage/temperature forces the DQS/RDWS to go out of the data valid window. This case is not covered in this demo application.



## 8 Application overview

This application after configuring the whole micro-controller, setup clocks and signals, then in a loop sequentially tests both OctalSPI\_1 and OctalSPI\_2. The focus is on the HyperBUS protocol implementation.

Below is the simple main function:

```
int main(void)
{
    int i, j;
    int fail = 0;

    componentsInit();
    irqIsrEnable();

    for (i=0; i < test_loops; i++) {
        for (j=0; j <=1 ; j++) {
            /* Arguments: instance number - delay block enabled */
            fail += HYPERRAM_Test(1, j);
            fail += HYPEFLASH_Test(2, j);
        }
    }
    printf("\nOCTALSPI result: %d failures in %d loops\r\n", fail, test_loops);
}
```

The first instance is mapped on the HyperRAM while the second one is mapped on HyperFLASH.

Both devices will be tested with a set of user case to check some features and robustness.

The test output is visible over serial console, a LINFLEX instance is properly configured as UART for this purpose. The LIN\_RX PIN PD[14] is configured as UART TX signal.

Before accessing the OctalSPI, the following platform setup must be applied to enable the controller accesses.

```
static void octalspi_pltfrm_setup(void)
{
    PMCDIG.VSIO.B.VSIO_EMMC = 0;
    PMCDIG.VSIO.B.VSIO_ETH1 = 0;

    SPCSetPeripheralClockMode(SPC5_OCTALSPI_PCTL, SPC5_ME_PCTL_RUN(1) |
    SPC5_ME_PCTL_LP(2));

    /* Reset of peripheral to clear all registers */
    MC_RGM.PRST2.B.OCTALSPI_RST = 1;
    MC_RGM.PRST2.B.OCTALSPI_RST = 0;

    /* This enables the multiplexing of the two OctoSPI.
     * Note: this can be done before init the devices. */
    OCTALSPI_IOM.IOM_CR.R = 1U;
}
```

Where:

```
#define SPC5_OCTALSPI_PCTL 77 /* -> Reference Manual - PCTL */
```

**Note:** *the two OSPI instances are embedded along with an IO manager. This is controlled by a single PCTL.*

### 8.1 HyperRAM application

After configuring the OctalSPI\_1, the following tests are executed on the device:

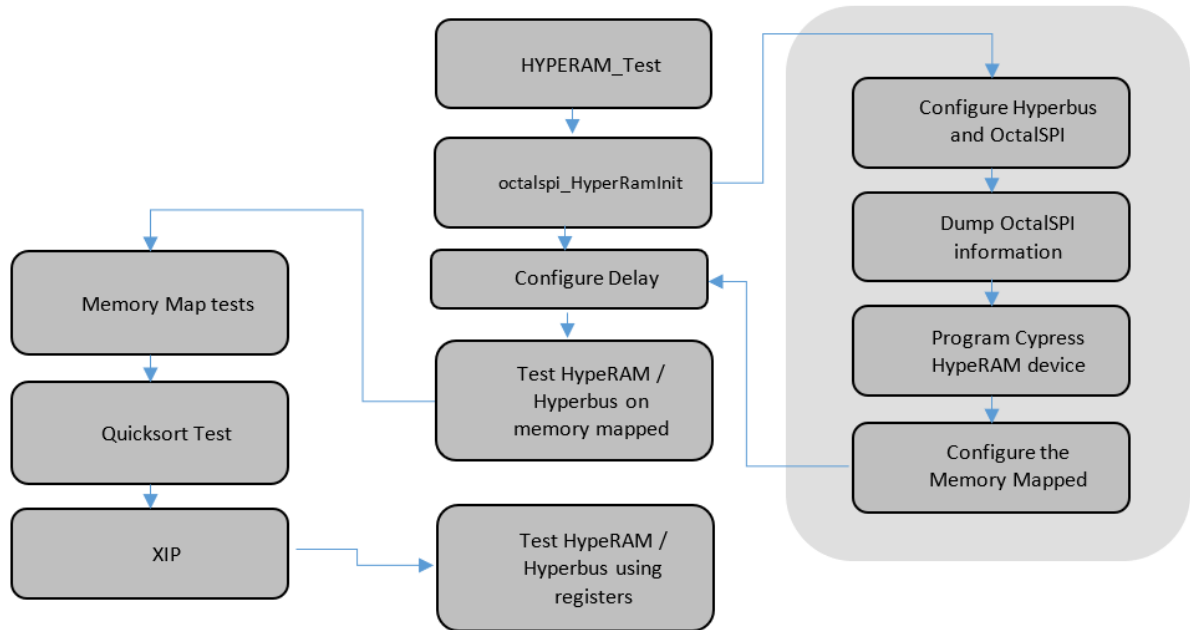
- The memory map space is filled with a fixed pattern and a memory copy is tested. The data moved from/to memory mapped space (e.g. 0x70000000) must be coherent.
- A quick sort algorithm is implemented. The data sorted in SRAM and on a memory mapped region must be equal.

- The indirect-mode transfer via registers.
- XIP mode (see the related paragraph).

In case an error occurs, while configuring the device, the application will exit with an error.

Any test failure will be logged and reported at the end of the execution. The following block diagram aims at summarizing the test execution.

**Figure 11. HyperRAM test simplified block schema**



### 8.1.1 HyperRAM configuration

The `HYPERRAM_Test` function configures the OctalSPI from scratch by invoking the following API:

```

static void octalspi_init(const ospi_cfg_t *config)
{
    octalspi_pltfrm_setup(); /* Platform configuration */

    octalspi->DCR1.B.MTYP = config->memoryType;
    octalspi->DCR1.B.DEVSIZE = config->deviceSize - 1;
    octalspi->DCR1.B.CSHT = config->chipSelectHighTime - 1;
    octalspi->DCR1.B.FRCK = config->freeRunningClock;
    octalspi->DCR1.B.CKMODE = config->clockMode;
    octalspi->DCR2.B.WRAPSIZE = config->wrapSize;
    octalspi->DCR2.B.PRESCALER = config->clockPrescaler;
    octalspi->DCR3.R = 0;
    octalspi->DCR3.B.CSBOUND = config->chipSelectBoundary;
    octalspi->CR.B.FTHRES = config->fifoThreshold - 1;
    /* Wait until the device is not BUSY */
    while (octalspi->SR.B.BUSY)
        osalThreadDelayMilliseconds(1UL);

    octalspi->CR.B.DQM = config->dualQuad;
    octalspi->TCR.B.SSHIFT = config->sampleShifting;
    octalspi->TCR.B.DHQC = config->delayHoldQuarterCycle;
    octalspi_ccr(); /* setup the communication configuration register */
    octalspi->CR.B.EN = 1; /* Enable the OctalSPI */
}
  
```

The `const ospi_cfg_t` is a structure to configure the OctalSPI device that is fixed in the project configuration. All the parameters used to fill this structure must be selected according to the memory device adopted.

When accessing to the HyperRAM device, the following configuration is used to access the device and get the information from registers, the fixed latency mode is adopted:

```
const ospi_hyperbus_cfg_t octalspi_HyperRAM_cypress_bus_conf = {
    4, /* Read write recovery time */
    6, /* Device access time */
    1, /* 1: no latency on Write to access registers */
    1 /* Latency mode => 0: variable, 1: fixed */
};
```

After configuring the device, the variable latency mode can be set up.

```
const ospi_hyperbus_cfg_t octalspi_HyperRAM_bus_conf = {
    4, /* Read write recovery time */
    6, /* Device access time */
    0, /* 0 latency on write to access HyperRAM (device dependent) */
    0 /* Latency mode => 0: variable, 1: fixed */
};
```

If a fixed latency is selected, the memory will always indicate a refresh latency and delay the read data transfer accordingly. If a variable latency is selected, a latency is only added when a refresh is required at the same time a new transaction is starting. A variable latency is preferred for performance reasons on these kind of memories. For variable latency, the device access time has to be up to 6. For the fixed latency it might decrease according to the frequency used.

See also [Section Appendix A HyperBus timing](#) for timing considerations.

The configuration is propagated to the cypress memory device by using another low-level driver. This will be described later.

In the HyperBus mode, the device timing (tACC and tRWR) and the latency mode must be configured in the OCTOSPI HyperBus latency configuration register as shown below:

```
void octalspi_HyperbusCfg(const ospi_hyperbus_cfg_t *config)
{
    octalspi->HLCR.R = 0;
    octalspi->HLCR.B.TRWR = config->rwRecoveryTime;
    octalspi->HLCR.B.TACC = config->accessTime;
    octalspi->HLCR.B.WZL = config->writeZeroLatency;
    octalspi->HLCR.B.LM = config->latencyMode;
}
```

The following function is used to select the memory map mode.

```
void octalspi_MemoryMapped(const ospi_cfg_t *config)
{
    octalspi->LPTR.R = 0U;
    octalspi->LPTR.B.TIMEOUT = config->timeoutPeriod;
    octalspi->CR.B.TCEN = config->timeoutActivation;
    octalspi->CR.B.FMODE = OSPI_FMODE_MEMORY_MAPPED;
    octalspi->DCR1.B.MTYP = config->memoryType;
}
```

The `memoryType`, according to the reference manual, can be programmed with the following values, considering that it should be set in HyperBus memory mode on this platform.

- 0** : Micron mode, D0/D1 ordering in DTR 8-data-bit mode.
- 1** : Macronix mode, D1/D0 ordering in DTR 8-data-bit mode.
- 3** : Macronix RAM mode, D1/D0 ordering in DTR 8-data-bit mode.
- 4** : HyperBus memory mode, the protocol follows the Cypress
- 5** : HyperBus register mode, addressing register space.

Switching to memory map mode, `memoryType` is equal to 4.

Concerning the functional modes, the application defines the following:

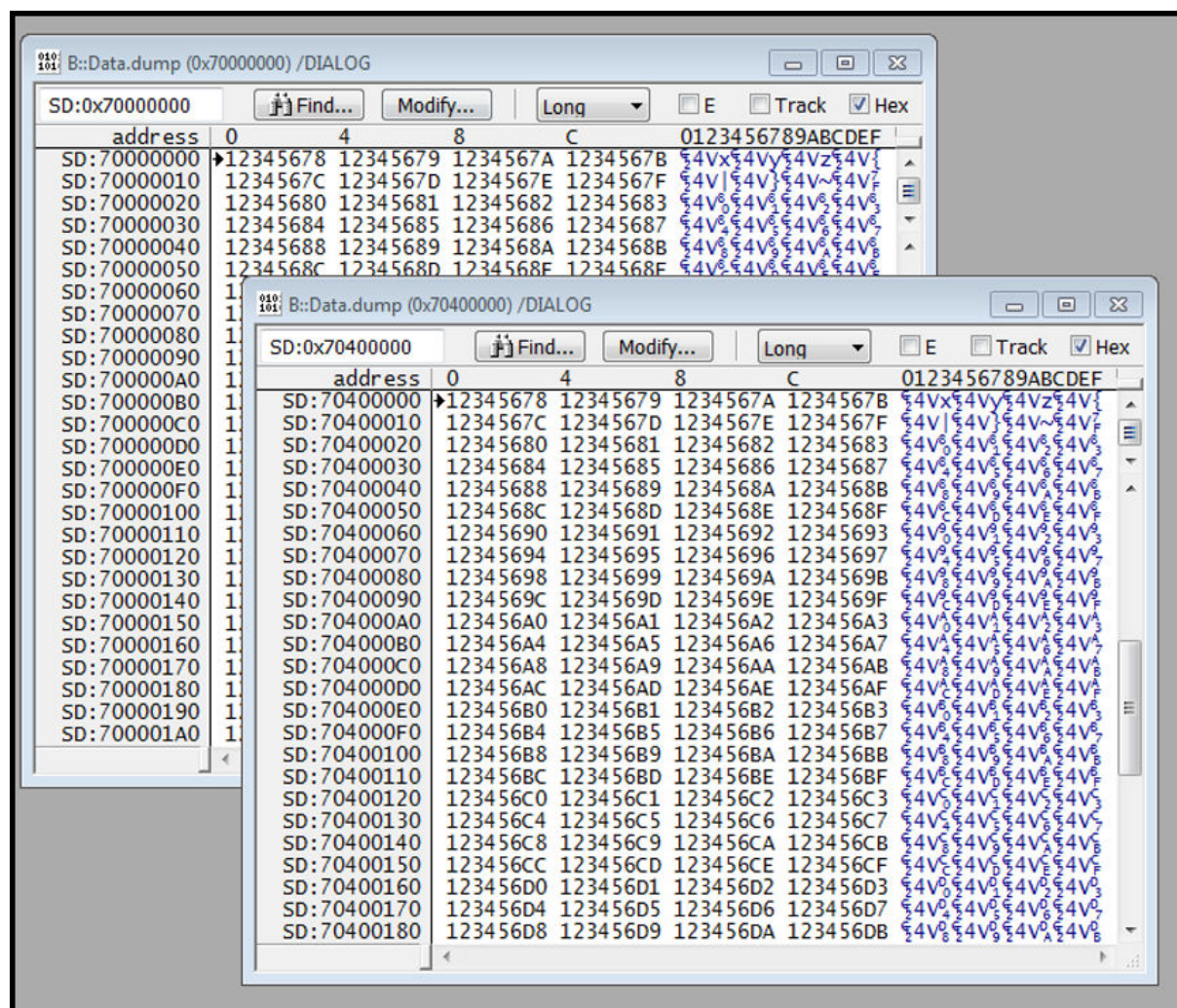
```
#define OSPI_FMODE_INDIRECT_WRITE    0
#define OSPI_FMODE_INDIRECT_READ      1
#define OSPI_FMODE_AUTO_POLLING      2
#define OSPI_FMODE_MEMORY_MAPPED     3
```

Completing the whole setup the application executes the battery of tests, mentioned above, to check the transfer through the memory map space. Completing those, a simple test using the indirect-mode is run as well.

### 8.1.2 Memory map example

The following figure shows a basic test where a block of the memory mapped space, e.g. 0x70000000, is filled with a pattern and then is copied to another memory. The test fails in case a bit differs.

Figure 12. Memory dump



### 8.1.3 Indirect mode example

In this mode, the following two APIs are implemented to write and read on the device by using the registers. This test just performs the write operation reading back the value. It fails in case just one bit differs.

```
void octalspi_HyperbusMemWrite(uint32_t *buffer, int size, uint32_t addr)
{
    int i;
    octalspi_HyperbusCommand(SPC5_OSPI_MEMTYPE_HYPERBUS_RAM, size, addr);
    octalspi->CR.B.FMODE = OSPI_FMODE_INDIRECT_WRITE;
    while (!(octalspi->SR.B.FTF)) {};

    for (i=0; i< size / (sizeof(uint32_t)); i++) {
        *((uint32_t *) &octalspi->DR.R) = buffer[i];
    }
    /* In polling mode checks the transfer status */
    octalspi_xfer_completed();
}

void octalspi_HyperbusMemRead(uint32_t *buffer, int size, uint32_t addr)
{
    int i;
    octalspi_HyperbusCommand(SPC5_OSPI_MEMTYPE_HYPERBUS_RAM, size, addr);

    octalspi->CR.B.FMODE = OSPI_FMODE_INDIRECT_READ;
    addr = octalspi->AR.R;
    octalspi->AR.R = addr;

    while (!(octalspi->SR.B.FTF)) {};

    for (i=0; i< size / (sizeof(uint32_t)); i++) {
        buffer[i] = *((uint32_t *) &octalspi->DR.R);
    }
    octalspi_xfer_completed();
}
```

The following code is to check if the transfer has been completed (no interrupt is used in this case):

```
static inline void octalspi_xfer_completed(void)
{
    while (!(octalspi->SR.B.TCF)) {};
    octalspi->FCR.B.CTCF = 1;
}
```

The `octalspi_HyperbusCommand` is invoked to prepare the transfer of data from/to the memory by programming the MTYP field in the device configuration register 1.

```
static void octalspi_HyperbusCommand(uint8_t memtype, uint32_t data_length, uint32_t address)
{
    while (octalspi->SR.B.BUSY){};
    /* Functional mode */
    octalspi->CR.B.FMODE = OSPI_FMODE_INDIRECT_WRITE;
    /* Memory Type to access on register or memory address */
    octalspi->DCR1.B.MTYP = memtype;
    /* Specify a number of data bytes to read or write in the OCTOSPI_DLR */
    octalspi_ccr();
    octalspi->DLR.R = data_length-1;
    /* Specify the targeted address in the OCTOSPI_AR */
    octalspi->AR.R = address;
}
```

## 8.2 Cypress low level driver

A low level driver is necessary to program the S71KL256SC0BHB000 device.

The designed driver provides a set of basic APIs to access the registers and implement a part of the protocol.

### 8.2.1 Cypress S27K HyperRAM

There are two identification read only, non-volatile, word registers, that provide information on the device plus two registers used for configuring power mode and access protocol operating conditions.

The following code is used to access these registers:

```
static void cypress_read_config_reg(void)
{
    uint16_t cfg0;
    uint16_t cfg1;

    cfg0 = octalspi_HyperbusRegRead(CYPRESS_CFG0_REG);
    cfg1 = octalspi_HyperbusRegRead(CYPRESS_CFG1_REG);
    ...
}
```

While the identification information can be read as shown below:

```
id0 = octalspi_HyperbusRegRead(CYPRESS_ID0_REG);
id1 = octalspi_HyperbusRegRead(CYPRESS_ID1_REG);
```

The offset of the mentioned registers is:

```
#define CYPRESS_ID0_REG 0x0
#define CYPRESS_ID1_REG 0x2
#define CYPRESS_CFG0_REG 0x1000
#define CYPRESS_CFG1_REG 0x1002
```

Through the configuration register 0 it is possible to define the operating conditions for the HyperRAM device and setting latency and initial latency modes or entering in power down.

### 8.2.2

#### Cypress S26K HyperFlash

To test the S26K HyperFLASH, the application invokes the cypress low level APIs for example to reset, erase and program the device.

The S26K does not use a traditional serial flash command protocol so the regular command protocol is not implemented.

To perform each operation the software must implement the device protocol to send the commands to the device in HyperBUS.

The cypress Programming Guide documents all supported commands, so this paragraph reports how the application implements one of them (for reference).

The code below shows the Cypress Macro Erase (Chip Erase) Command Sequence List. According to the protocol, this is completed in 6 cycles with a sequence of ADDRESS/DATA. The octalspi\_HyperbusMemWrite8 is invoked to access the device according to the APIs mentioned in the previous sections.

```

/*
 *
 *      1st      2nd      3rd      4th      5th      6th
 *
 *      555h|00AAh 2AAh|0055h 555h|0080h 555|00AAh 2AAh|0055h 2AAh|0010
 */
void cypress_flash_erase(void)
{
    int i;
    uint8_t *status;
    uint32_t erase_address[6] = { ADDR_PATTERN_1, ADDR_PATTERN_2,
        ADDR_PATTERN_1, ADDR_PATTERN_1,
        ADDR_PATTERN_2, ADDR_PATTERN_1};

    uint8_t erase_data[2*6] = {DATA_PATTERN_1, 0x00, DATA_PATTERN_2, 0x00,
        ERASE_CMD, 0x00, DATA_PATTERN_1, 0x00,
        DATA_PATTERN_2, 0x00,
        CHIP_ERASE_CMD, 0x00};

    for (i=0; i < 6; i++) {
        octalspi_HyperbusMemWrite8(&erase_data[2*i], 2, erase_address[i]);
    }
    do {
        status = cypress_read_status();
    } while(!(status[0] & 0x80)); /* READY BIT SR[7] */

    printf("S26K HyperFlash erase phase completed\r\n");
}

```

Where:

```

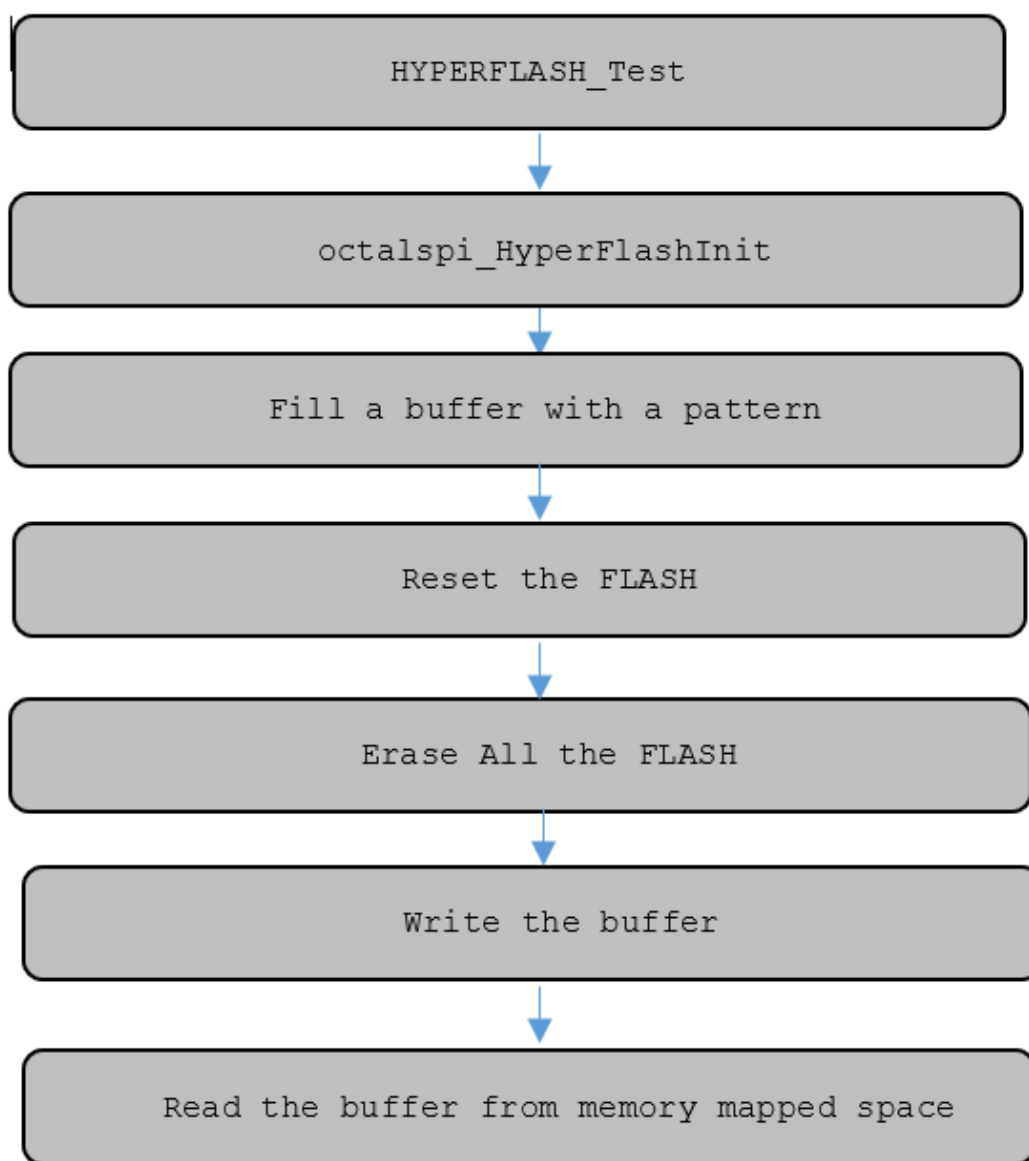
#define ADDR_PATTERN_1 (0x555 << 1)
#define ADDR_PATTERN_2 (0x2AA << 1)
#define DATA_PATTERN_1 0xAA
#define DATA_PATTERN_2 0x55

```

## 8.3 HyperFLASH application

After configuring the OctalSPI to use the HyperFLASH, the applications have to reset and erase the whole flash. Then a user buffer is filled and written to the device. The application reads back the buffer from memory map and fails if any bits differ.



**Figure 13. HyperFLASH block schema**


## 8.4 HyperRAM XIP test

The execute in place (XIP) operation is implemented in this architecture. The XIP feature allows to execute programs directly from the external device.

This paragraph aims at showing how to test this kind of feature where a program is placed in HyperRAM.

The first step is to prepare an application that will be copied in the external memory. For this purpose, a very simple main has been developed: it just writes a pattern to a known address, e.g.: 0x70001000.

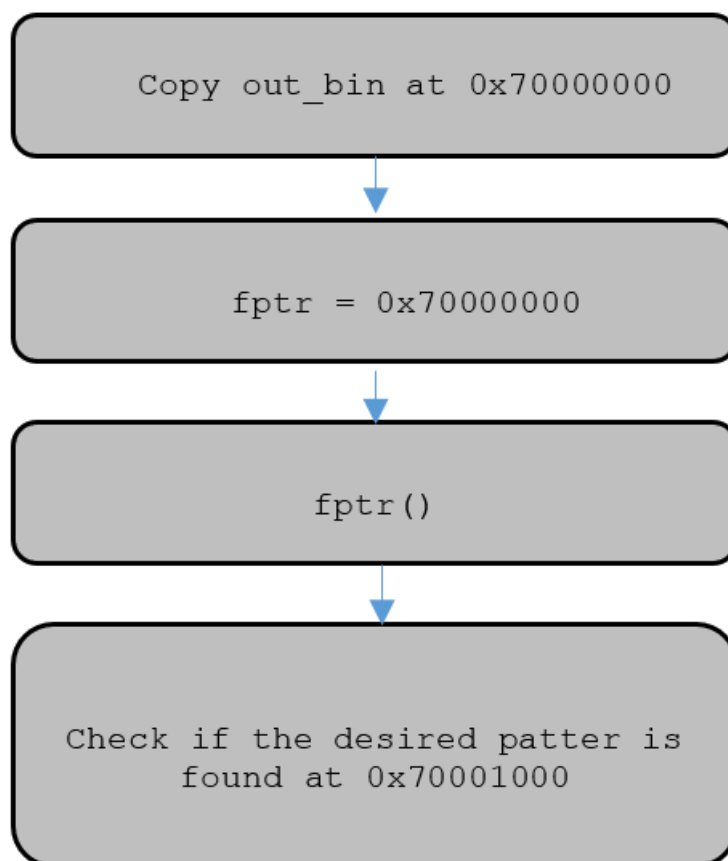
Then its binary data are converted into a source header file:

```

static const unsigned char out_bin[] = {
    0x70, 0x1e, 0xe0, 0xcb, 0x71, 0x82, 0x00, 0x00, 0x1c, 0x00, 0xcc, 0x1a,
    0x71, 0x60, 0x00, 0x64, 0x19, 0x8c, 0x83, 0x70, 0x7d, 0x69, 0x03, 0xa6,
    0x19, 0x8c, 0x84, 0xfc, 0x18, 0x0c, 0x06, 0x04, 0x20, 0x00, 0x7a, 0x20,
    0xff, 0xfa, 0x48, 0x03, 0x00, 0x04, 0x00, 0xb3, 0x00, 0x07, 0x18, 0x00,
    0xd0, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00,
    0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x03, 0xe8
};
  
```

This header file can be included in the OctalSPI application and, at runtime, the application copies it inside the HyperRAM at the following address: 0x70000000. It is necessary to take care about the endianness.

**Figure 14. XIP block schema**



After copying the binary in the selected portion of the external device, the code can jump to it (see block schema above). As soon as the `out_bin` code is executed, the program counter will keep on the caller. The following debug session shows the result of the execution of the `out_bin`.

**Figure 15. XIP test result**

## 8.5 Interrupts handling

Table 5. OctalSPI interrupt shows the interrupt mapping for the two controllers.

**Table 5. OctalSPI interrupt**

IRQ Name	OctalSPI1		OctalSPI2	
	Number		Number	
Global Interrupt	186		192	
Timeout	187		193	
Status match	188		194	
FIFO threshold	189		195	
Transfer complete	190		196	
Transfer error	191		197	

The global interrupt vector handles the other five interrupts. The following code is to install the global interrupt inside the SPC5Studio tool.

```
#define SPC5_OCTALSPI_1_HANDLER      vector186
#define SPC5_OCTALSPI_2_HANDLER      vector192
#define SPC5_OCTALSPI_1_NUMBER      186
#define SPC5_OCTALSPI_2_NUMBER      192
#define SPC5_OCTALSPI_PRIORITY      INTC_PSR_ENABLE(INTC_PSR_CORE2, 10)

IRQ_HANDLER(SPC5_OCTALSPI_1_HANDLER) {
    IRQ_PROLOGUE();
    osalEnterCriticalFromISR();
    octalspi_main_isr(); /* Interrupt Service Routine */
    osalExitCriticalFromISR();
    IRQ_EPILOGUE();
}
...
void octalspi_irq_install(unsigned int instance)
{
    if (instance == 1)
        INTC_PSR ( SPC5_OCTALSPI_1_NUMBER ) = SPC5_OCTALSPI_PRIORITY;
    else
        INTC_PSR ( SPC5_OCTALSPI_2_NUMBER ) = SPC5_OCTALSPI_PRIORITY;

    /* Enable the IRQ events */
    octalspi_EnableIRQ();
}
```

Where the `octalspi_main_isr` is the low-level APIs that just enables, inside the control register (CR) the related IRQ, i.e.:

- Timeout interrupt enable (TOIE)
- Status match interrupt enable (SMIE)
- FIFO threshold interrupt enable (FTIE)
- Transfer complete interrupt enable (TCIE)
- Transfer error interrupt enable (TEIE)

*Note:* refer to OctalSPI related guide inside the Reference manual for a complete description of the bits mentioned above (see [Section Appendix C Reference documents](#)).

*Note:* in the examples reported in the previous chapters the transfer status is checked in polling mode to better show the flow of each single operation.

The application configuration adopts a specific defines macro to enable / disable interrupt support.

## 8.6 Automatic polling mode

The status match flag is set in automatic-polling mode when the unmasked received data match the corresponding bits in the match register (OCTOSPI\_PSMAR). This paragraph shows an example code on how to configure this mode (HyperBUS / Regular Command protocols) and also shows a diagram that aims at detailing the logic flow.

```
uint32_t octalspi_AutoPollingHyperBUS(ospi_polling_cfg_t *cfg, uint32_t poll_addr)
{
    /*
     * If PSMAR.B.MASK[n] = 1 and the content of bit[n] is the same as
     * PSMAR.B.MATCH[n] so the match is satisfied.
     *
     * If PSMAR.B.MASK[n] = 0, so the bit n is masked and not considered.
     */
    octalspi->PSMAR.B.MATCH = cfg->Match;
    octalspi->PSMKR.B.MASK = cfg->Mask;
    octalspi->PIR.B.INTERVAL = cfg->Interval;

    octalspi->CR.B.FMODE = OSPI_FMODE_AUTO_POLLING;
    /* 1: stop after a match */
    octalspi->CR.B.APMS = cfg->AutomaticStop;
    /*
     * Match Mode: 0: AND, 1: OR
     *
     * In AND mode means that only when there is a match on all of the
     * unmasked bits, then the status match flag (SMF) is set.
     *
     * then "OR" match mode is activated, which means that the SMF gets set if
     * there is a match on any of the unmasked bits.
     *
     * BUSY goes to 0 as soon as a match is detected
     *
     * OCTOSPI_DLR = 1, 8bit
     */
    octalspi->CR.B.PMM = cfg->MatchMode;

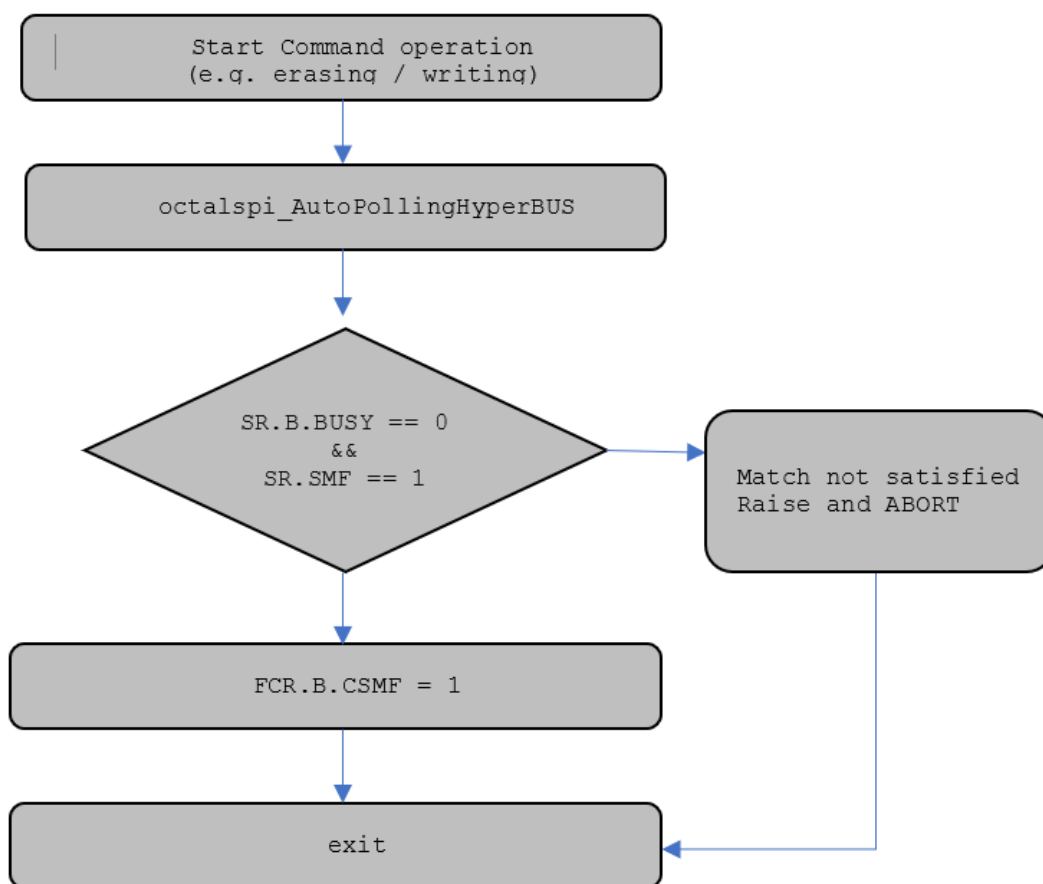
    /* The maximum amount of data read in each frame is 4 bytes. If more data is
     * requested in OCTOSPI_DLR, it will be ignored and only 4 bytes will be
     * read.
     */
    octalspi->DLR.R = 3;
    /* The command sequence starts as soon as the address is updated
     * with a write to OCTOSPI_AR */
    /* Targeted address is saved in the OCTOSPI_AR */
    octalspi->AR.R = poll_addr;

    /* Note: In automatic polling mode, OCTOSPI_DR contains the last data read
     * from the external device (without masking).
     *
     * Same can be done by using IR register.
     */
}
```

**Note:** *When programming the match mask and read the DR register, the endianness format must be considered because the data could be swapped due to a different flash device endianness.*

**Note:** *Used values: #define DLYB\_MAX\_UNIT 127U; #define DLYB\_CFGR\_LNG\_11 0x800U*

**Figure 16. Automatic polling mode (generic flow diagram)**



**Note:** The reference manual gives a detailed description of the matching flag programming and the controller status on each state of the polling mode (see [Section Appendix C Reference documents](#)).

## 8.7 Application output

On the serial console the following output messages are logged for both OctalSPI 1 and OctalSPI2 tests.

**Note:** After the configuration of the peripheral and delay block, all the test can be executed in one or more loops.

### 8.7.1 HyperRAM test output

```

=====
OctalSPI Application
=====
OCTALSPI_1 (0x80000000 - 0x70000000)

OctalSPI version: 0x22, ID 0x140041, Magic ID 0xA3C5DD01
device configured as Master
Memory mapped write present
AHB interface
No memory mapped write 8 byte
DelayBlock_Enable (OCTSPI_1)
Delay Block Tuning completed
HyperBus Configuration
- Read write recovery time = 4
- Device access time = 6
- no latency on Write
- Fixed latency Mode
Found Cypress Manufacturer ID
HyperRAM mode selected
- 64 Mbit
Card Configuration reg: 0x8F17, 0x2
HyperBus Configuration
- Read write recovery time = 4
- Device access time = 6
- latency on Write
- Variable latency Mode

-- S27K HyperRAM Test --
TEST 1: filled 131072 byte of memory (0x70000000)
TEST 1: memcpy check PASSED
TEST 2: Quick Sort Test
TEST 2: QuickSort PASSED
TEST 3: transfer through registers PASSED
DelayBlock_Disable (OCTSPI_1)

Reconfiguring the Hyperbus ...
OctalSPI version: 0x22, ID 0x140041, Magic ID 0xA3C5DD01
device configured as Master
Memory mapped write present
AHB interface
No memory mapped write 8 byte
DelayBlock_Enable (OCTSPI_1)
Delay Block Tuning completed
TEST 4: XIP test: PASSED
DelayBlock_Disable (OCTSPI_1)

```



## 8.7.2 HypeFLASH test output

```
OCTALSPI_2 (0x80001000 - 0x60000000)
-- S26K HyperFlash Test --
OctalSPI version: 0x22, ID 0x140041, Magic ID 0xA3C5DD01
device configured as Slave
Memory mapped write present
AHB interface
No memory mapped write 8 byte
DelayBlock_Enable (OCTSPI_2)
Delay Block Tuning completed
HyperBus Configuration
- Read write recovery time = 0
- Device access time = 16
- no latency on Write
- Variable latency Mode
S26K HyperFlash reset done
S26K HyperFlash erase phase completed
[Writing data 0x528003C0 (512 bytes)]
S26K HyperFlash write test done: 512 bytes
>>> Reconfiguring the Hyperbus for memory mapped addressing...
HyperBus Configuration
- Read write recovery time = 0
- Device access time = 16
- no latency on Write
- Variable latency Mode
DelayBlock_Disable (OCTSPI_2)
TEST: memory mapped data are coherent

Test Completed!
```

## Appendix A HyperBus timing

The commands, the addresses and data are transferred over the eight DATA [7:0] signals. The clock is used for information capture by the device. The command or address values are aligned with clock transitions which start with the assertion of CS# and Command-Address (CA) signals. These are followed by the start of clock transitions to transfer six command bytes. Then there is the initial access latency and either read or write data transfers, until the chip select is de-asserted.

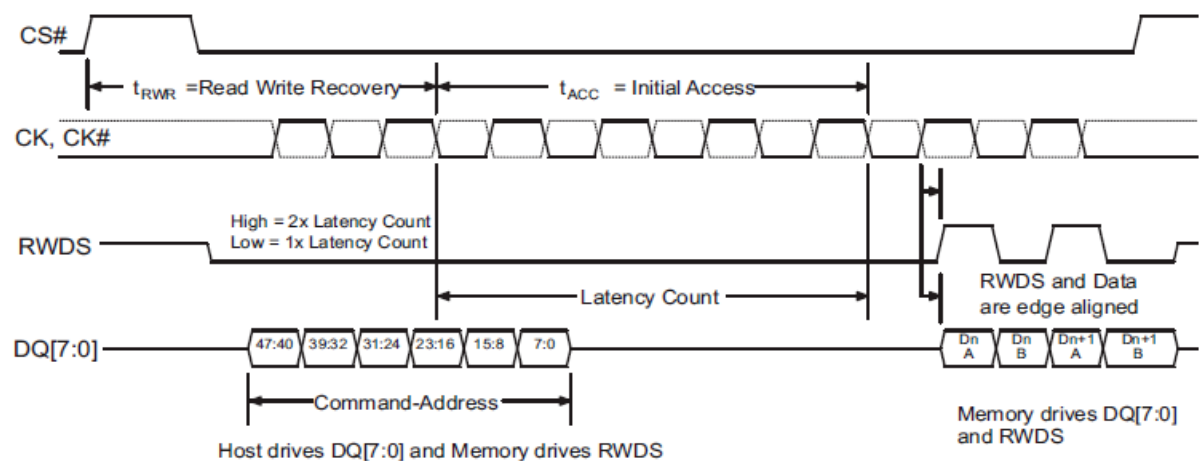
The read and write operations need to respect two timings:  $t_{RWR}$  that is the minimal read/write recovery time for the device and  $t_{ACC}$  used as access time for the device. Both must be programmed in the OctalSPI registers as shown below:

```
octalspi->HLCR.B.TRWR = config->rwRecoveryTime;
octalspi->HLCR.B.TACC = config->accessTime;
```

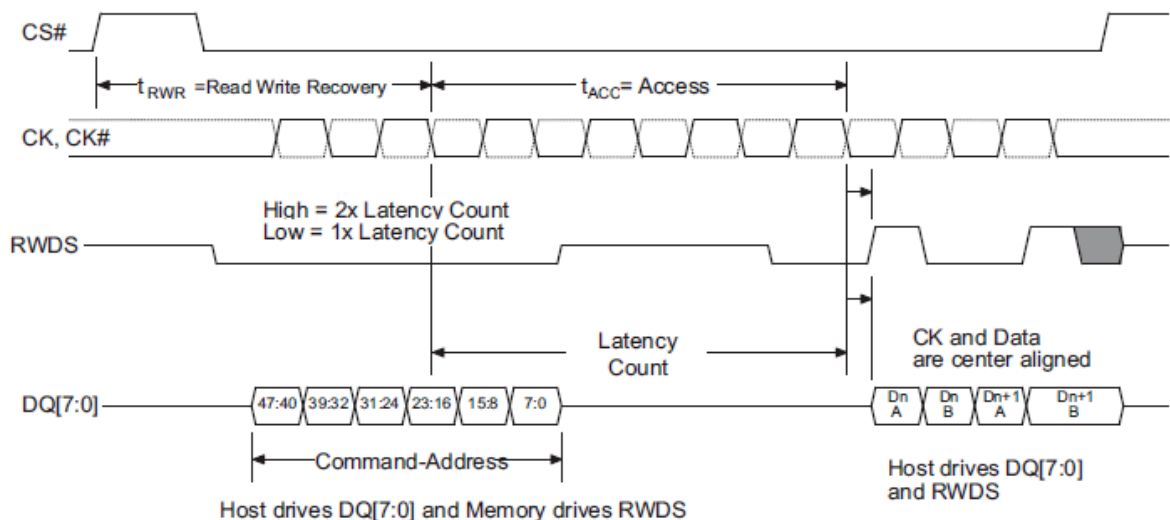
The DRAM cells cannot be refreshed during a read or write transactions: a host is required to limit the duration of transactions and allow an additional initial access latency as well. An additional latency is before  $t_{ACC}$  and after RWR and it is driven by the RWDS signal.

If a variable latency is selected, a latency for a refresh is only added when a refresh is required at the same time a new transaction is starting.

**Figure 17. Read operation with an initial latency**



**Figure 18. Write operation with an initial latency**



It is possible to force the latency to be fixed to  $2 \times t_{ACC}$  by programming the following register:

```
octalspi->HLCR.B.LM = 1;
```

The state of the RWDS signal is not considered in this mode. If a fixed latency is selected the memory will always indicate a refresh latency and delay the read data transfer accordingly.

## Appendix B Acronyms and abbreviations

Table 6. Acronyms

Abbreviation	Complete name
SIUL2	System integration unit lite 2
CGM	Clock Generation Module
XIP	Execution in place
SRAM	System RAM
PCM	Platform configuration module
PSR	Protocol Status Register
SDR/DDR	Single / Double Data Rate

## Appendix C Reference documents

**Table 7. Reference documents**

Name	Title
RM0452	SPC58EHx/SPC58NHx 32-bit Power Architecture microcontroller
DS12304	SPC58EHx/SPC58NHx Errata sheet, Datasheet and IO map excel file
-	S27KL0641/S27KS0641 S70KL1281/S70KS1281 3.0 V/1.8 V, 64 Mbit (8 Mbyte)/128 Mbit (16 Mbyte), HyperRAM™ Self-Refresh DRAM
-	S71KL256SC0_S71KL512SC0, HYPERFLASH AND HYPERRAM MULTI CHIP PACKAGE 3 V

## Revision history

**Table 8. Document revision history**

Date	Version	Changes
05-Nov-2020	1	Initial release.
05-Mar-2024	2	Updated Table 4. Hold margin according to a DQS delayed by + 0.8 ns; Section 7.3 Delay block length tuning. Added Section 7.3.1 . Minor text changes.

## Contents

<b>1</b>	<b>OctalSPI introduction</b>	<b>2</b>
1.1	OctalSPI protocol and operating modes	2
1.1.1	Regular command mode	2
1.1.2	HyperBUS mode	2
1.2	OctalSPI operating modes	3
1.2.1	Indirect mode	3
1.2.2	Memory-mapped mode	3
1.2.3	Status polling mode	3
<b>2</b>	<b>SPC58EHx/SPC58NHx OctalSPI mapping</b>	<b>4</b>
<b>3</b>	<b>OctalSPI clock selection</b>	<b>5</b>
<b>4</b>	<b>Hardware setup</b>	<b>7</b>
<b>5</b>	<b>HyperRAM multi-chip package</b>	<b>8</b>
<b>6</b>	<b>OctalSPI signals</b>	<b>10</b>
<b>7</b>	<b>Delay block overview</b>	<b>11</b>
7.1	Delay block timing example	11
7.2	Delay block enable	13
7.3	Delay block length tuning	14
7.3.1	Code/algorithm description	14
<b>8</b>	<b>Application overview</b>	<b>16</b>
8.1	HyperRAM application	16
8.1.1	HyperRAM configuration	17
8.1.2	Memory map example	19
8.1.3	Indirect mode example	19
8.2	Cypress low level driver	20
8.2.1	Cypress S27K HyperRAM	20
8.2.2	Cypress S26K HyperFlash	21
8.3	HyperFLASH application	22
8.4	HyperRAM XIP test	23
8.5	Interrupts handling	25
8.6	Automatic polling mode	26



8.7	Application output .....	28
8.7.1	HyperRAM test output .....	29
8.7.2	HypeFLASH test output .....	30
<b>Appendix A</b>	<b>HyperBus timing .....</b>	<b>31</b>
<b>Appendix B</b>	<b>Acronyms and abbreviations .....</b>	<b>33</b>
<b>Appendix C</b>	<b>Reference documents .....</b>	<b>34</b>
	<b>Revision history .....</b>	<b>35</b>
	<b>Contents .....</b>	<b>36</b>
	<b>List of tables .....</b>	<b>38</b>
	<b>List of figures .....</b>	<b>39</b>

## List of tables

<b>Table 1.</b>	OctalSPI memory map . . . . .	4
<b>Table 2.</b>	OctalSPI IO mapping . . . . .	10
<b>Table 3.</b>	Hold margin according to a DQS delayed by - 0.8 ns . . . . .	12
<b>Table 4.</b>	Hold margin according to a DQS delayed by + 0.8 ns . . . . .	12
<b>Table 5.</b>	OctalSPI interrupt . . . . .	25
<b>Table 6.</b>	Acronyms . . . . .	33
<b>Table 7.</b>	Reference documents . . . . .	34
<b>Table 8.</b>	Document revision history . . . . .	35

## List of figures

<b>Figure 1.</b>	OCTSPI_CLK GCM selection . . . . .	5
<b>Figure 2.</b>	Application clock details (SPC5Studio wizard) . . . . .	5
<b>Figure 3.</b>	OctalSPI prescaler selection ( $200 / 2 = 100$ MHz) . . . . .	6
<b>Figure 4.</b>	SPC58NHADPT302S board . . . . .	7
<b>Figure 5.</b>	S71KL256SC0BHB000 package . . . . .	8
<b>Figure 6.</b>	S71KL256SC0BHB000 wiring . . . . .	9
<b>Figure 7.</b>	DQS and data signals aligned . . . . .	11
<b>Figure 8.</b>	DQS is delayed by -0.8 ns and DLYBLK adds 1/12 as correction. . . . .	12
<b>Figure 9.</b>	Delay block enable procedure . . . . .	13
<b>Figure 10.</b>	Delay block tuning. . . . .	15
<b>Figure 11.</b>	HyperRAM test simplified block schema. . . . .	17
<b>Figure 12.</b>	Memory dump . . . . .	19
<b>Figure 13.</b>	HyperFLASH block schema . . . . .	23
<b>Figure 14.</b>	XIP block schema . . . . .	24
<b>Figure 15.</b>	XIP test result. . . . .	25
<b>Figure 16.</b>	Automatic polling mode (generic flow diagram) . . . . .	28
<b>Figure 17.</b>	Read operation with an initial latency. . . . .	31
<b>Figure 18.</b>	Write operation with an initial latency. . . . .	31

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